SDAS224B - JUNE 1982 - REVISED NOVEMBER 1995

- Compare Two 8-Bit Words
- Choice of Totem-Pole or Open-Collector Outputs
- SN74ALS518 and 'ALS520 Have 20-kΩ
 Pullup Resistors on Q Inputs
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

| TYPE | INPUT PULLUP RESISTOR | OUTPUT FUNCTION AND CONFIGURATION |
|-------------------------|-----------------------------|---|
| SN74ALS518 | Yes | P = Q open collector |
| 'ALS520 | Yes | P = Q totem pole |
| SN74ALS521 [‡] | No | P = Q totem pole |

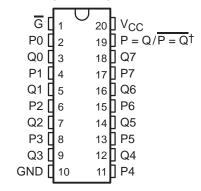
^{\$\}frac{1}{7}\$ SN74ALS521 is identical to 'ALS688.

description

These identity comparators perform comparisons on two 8-bit binary or BCD words. The SN74ALS518 provides P = Q outputs, while the 'ALS520 and SN74ALS521 provide $\overline{P} = \overline{Q}$ outputs. The SN74ALS518 has an open-collector output. The SN74ALS518 and 'ALS520 feature 20-k Ω pullup resistors on the Q inputs for analog or switch data.

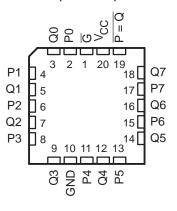
The SN54ALS520 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS518, SN74ALS520, and SN74ALS521 are characterized for operation from 0°C to 70°C.

SN54ALS520 . . . J PACKAGE SN74ALS518, SN74ALS520, SN74ALS521 . . . DW OR N PACKAGE (TOP VIEW)



 † P = Q for SN74ALS518 P = Q for 'ALS520 and SN74ALS521

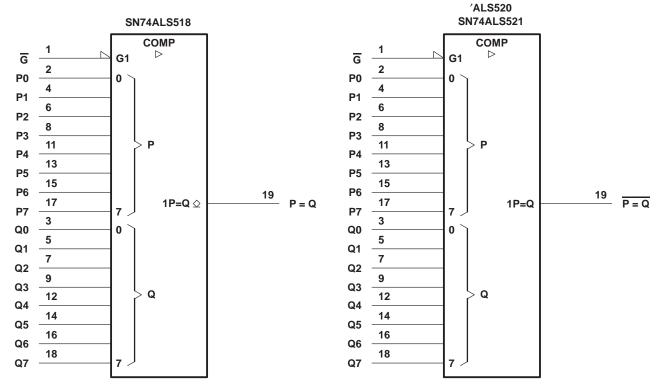
SN54ALS520 . . . FK PACKAGE (TOP VIEW)



FUNCTION TABLE

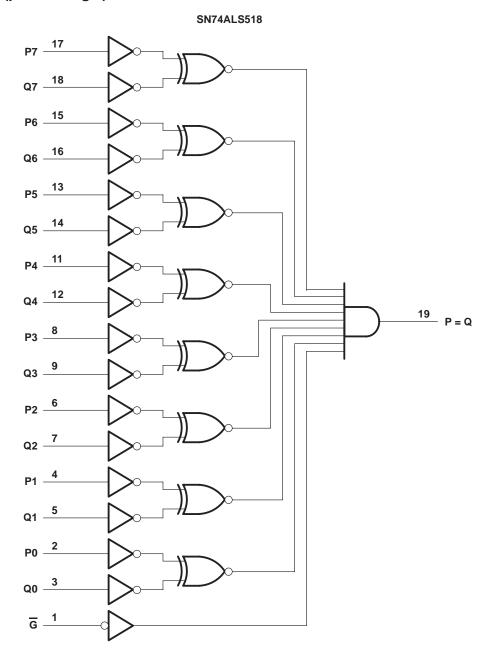
| IN | PUTS | OUTPUTS | | | | |
|--------------|-------------|---------|-------|--|--|--|
| DATA P, Q | ENABLE G | P = Q | P = Q | | | |
| P = Q | L | Н | L | | | |
| P > Q | L | L | Н | | | |
| P < Q | L | L | Н | | | |
| Х | Н | L | Н | | | |

logic symbols†

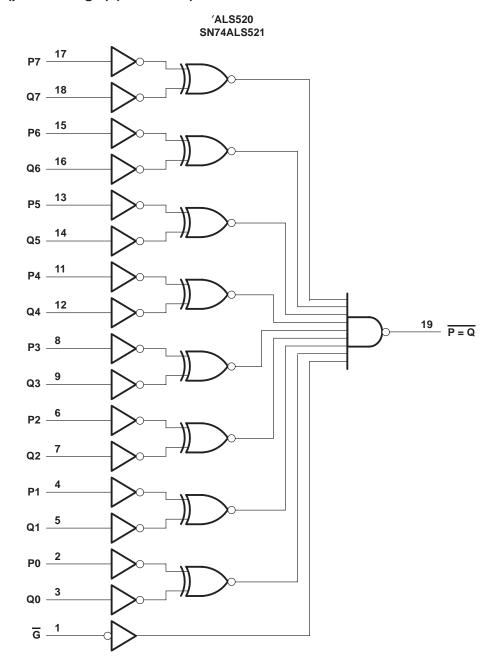


[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagrams (positive logic)



logic diagrams (positive logic) (continued)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage, V _{CC} | |
|---|---|
| Input voltage, V _I : Q inputs | V _{CC} + 0.5 V or 5.5 V, whichever is less |
| All other inputs | |
| Off-state output voltage | |
| Operating free-air temperature range, T _A : SN74ALS518 | |
| Storage temperature range | -65°C to 150°C |

recommended operating conditions

| | | SN | 74ALS5 | 18 | UNIT |
|----------|--------------------------------|-----|--------|-----|------|
| | | MIN | NOM | MAX | UNIT |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | V |
| VIH | High-level input voltage | 2 | | | V |
| V_{IL} | Low-level input voltage | | | 0.8 | V |
| Vон | High-level output voltage | | | 5.5 | V |
| loL | Low-level output current | | | 24 | mA |
| TA | Operating free-air temperature | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | DADAMETED | TEST COM | TEST CONDITIONS | | | | | |
|----------------|------------------|--|--------------------------|--|------|------|------|--|
| PARAMETER | | TEST CONI | TEST CONDITIONS | | | | | |
| ٧ıK | | V _{CC} = 4.5 V, | $I_{I} = -18 \text{ mA}$ | | | -1.5 | V | |
| loh | | V _{CC} = 5.5 V, | V _{OH} = 5.5 V | | | 0.1 | mA | |
| | | V00 - 45 V | I _{OL} = 12 mA | | 0.25 | 0.4 | V | |
| VOL | | V _{CC} = 4.5 V | $I_{OL} = 24 \text{ mA}$ | | 0.35 | 0.5 | V | |
| 1. | Q inputs | V00 - 5 5 V | V _I = 5.5 V | | | 0.1 | mA | |
| 1 ₁ | All other inputs | V _{CC} = 5.5 V | V _I = 7 V | | | 0.1 | IIIA | |
| la c | Q inputs | \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\ | V _I = 2.7 V | | | -0.2 | mA | |
| ¹IН | All other inputs | V _{CC} = 5.5 V, | V = 2.7 V | | | 20 | μΑ | |
| l | Q inputs | \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\ | V _I = 0.4 V | | | -0.6 | mA | |
| IIL | All other inputs | V _{CC} = 5.5 V, | V = U.4 V | | | -0.1 | IIIA | |
| ICC | · | V _{CC} = 5.5 V, | See Note 1 | | 11 | 17 | mA | |

‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ}\text{C}$.

NOTE 1: ICC is measured with G grounded, and P and Q at 4.5 V.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

SN54ALS520, SN74ALS518, SN74ALS520, SN74ALS521 8-BIT IDENTITY COMPARATORS

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switching characteristics (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} = 4.5 C _L = 50 pF R _L = 680 Ω T _A = MIN to SN74A | o MAX† | UNIT |
|------------------|-----------------|----------------|---|--------|------|
| t _{PLH} | D. a.r. O | Б. О | 15 | 33 | no |
| ^t PHL | P or Q | P = Q | 3 | 15 | ns |
| t _{PLH} | G | P = Q | 15 | 33 | |
| t _{PHL} | J | Γ≅Q | 3 | 15 | ns |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| Supply voltage, V _{CC} | 7 V |
|--|------------------|
| Input voltage, V _I : Q inputs of 'ALS520 V _{CC} + 0.5 V or 5.5 V, wh | nichever is less |
| All other inputs | 7 V |
| Operating free-air temperature range, T _A : SN54ALS520 – | ·55°C to 125°C |
| SN74ALS520, SN74ALS521 | . 0°C to 70°C |
| Storage temperature range – | ·65°C to 150°C |

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

| | | SN | 54ALS5 | 20 | SN SN | UNIT | | |
|----------|--------------------------------|-----|--------|-----|----------|------|------|----|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V |
| V_{IH} | High-level input voltage | 2 | | | 2 | | | V |
| V_{IL} | Low-level input voltage | | | 0.7 | | | 0.8 | V |
| ІОН | High-level output current | | | -1 | | | -2.6 | mA |
| loL | Low-level output current | | | 12 | | | 24 | mA |
| TA | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | PARAMETER | TEST COI | NDITIONS | SN | 54ALS5 | 20 | SN74ALS520 SN74ALS521 | | | UNIT |
|-----------------|------------------|---|----------------------------|--------------------|--------|------|--------------------------|------|------|------|
| | | | MIN | TYP [†] | MAX | MIN | TYP [†] | MAX | | |
| ٧ıK | | V _{CC} = 4.5 V, | $I_{I} = -18 \text{ mA}$ | | | -1.5 | | | -1.5 | V |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ | $I_{OH} = -0.4 \text{ mA}$ | V _{CC} -2 | 2 | | V _{CC} -2 |) | | |
| Vон | | V45V | $I_{OH} = -1 \text{ mA}$ | 2.4 | 3.3 | | | | | V |
| | | V _{CC} = 4.5 V | $I_{OH} = -2.6 \text{ mA}$ | | | | 2.4 | 3.2 | | |
| V/01 | | V00 - 45 V | I _{OL} = 12 mA | | 0.25 | 0.4 | | 0.25 | 0.4 | V |
| VOL | | VCC = 4.5 V | I _{OL} = 24 mA | | | | 0.35 | | 0.5 | V V |
| ı. | 'ALS520 Q inputs | V00 - 5 5 V | V _I = 5.5 V | | | 0.1 | | | 0.1 | mA |
| 11 | All other inputs | VCC = 5.5 V | V _I = 7 V | | | 0.1 | | | 0.1 | mA |
| | 'ALS520 Q inputs | V 55V | V- 2.7.V | | | -0.2 | | | -0.2 | mA |
| lіН | All other inputs | $V_{CC} = 5.5 \text{ V},$ | $V_1 = 2.7 \text{ V}$ | | | 20 | | | 20 | μΑ |
| | 'ALS520 Q inputs | V 55V | V: 0.4.V | | | -0.6 | | | -0.6 | A |
| IIL. | All other inputs | V _{CC} = 5.5 V, | $V_{ } = 0.4 \text{ V}$ | | | -0.1 | | | -0.1 | mA |
| 10 [‡] | | V _{CC} = 5.5 V, | V _O = 2.25 V | -20 | | -112 | -30 | | -112 | mA |
| | 'ALS520 | V 55V | | | 12 | 19 | | 12 | 19 | A |
| ICC | SN74ALS521 | V _{CC} = 5.5 V, | See Note 1 | | 12 | 19 | | 12 | 19 | mA |

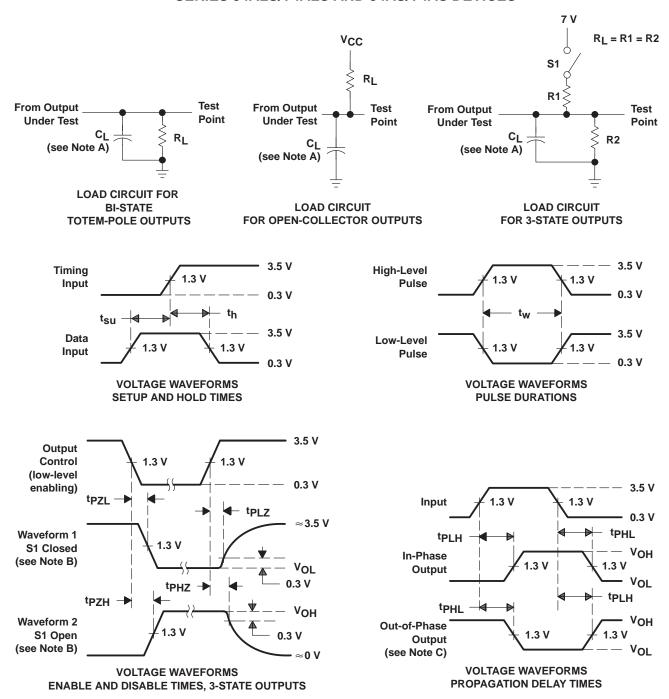
switching characteristics (see Figure 1)

| PARAMETER | FROM | то | $V_{CC} = 4.5$ $C_{L} = 50 \text{ p}$ $R_{L} = 500$ $T_{A} = \text{MIN}$ SN54ALS520 | | , 2, | V, | UNIT |
|------------------|---------|----------|---|------------|--------------------|----------------|------|
| | (INPUT) | (OUTPUT) | SN54A | SN54ALS520 | | LS520 LS521 | |
| | | | MIN | MAX | MIN | MAX | |
| t _{PLH} | D ar O | | 3 | 19 | 3 | 12 | 20 |
| t _{PHL} | P or Q | P = Q | 3 | 25 | 5 | 20 | ns |
| tPLH | G | P = Q | 2 | 18 | 2 | 12 | ns |
| ^t PHL | 0 | 1 – α | 5 | 23 | 5 | 22 | 115 |

[§] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, los. NOTE 1: I_{CC} is measured with \overline{G} grounded, and P and Q at 4.5 V.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_f = t_f = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms





5-Sep-2011

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/ Ball Finish | MSL Peak Temp ⁽³⁾ | Samples (Requires Login) |
|------------------|------------|--------------|--------------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| 5962-88691012A | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Call TI | |
| 5962-8869101RA | ACTIVE | CDIP | J | 20 | 1 | TBD | Call TI | Call TI | |
| SN54ALS520J | ACTIVE | CDIP | J | 20 | 1 | TBD | A42 | N / A for Pkg Type | |
| SN74ALS518DW | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS518DWE4 | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS518DWG4 | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS518N | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | |
| SN74ALS518NE4 | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | |
| SN74ALS520DW | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS520DWE4 | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS520DWG4 | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS520N | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | |
| SN74ALS520NE4 | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | |
| SN74ALS520NSR | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS520NSRE4 | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS520NSRG4 | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS521DW | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS521DWE4 | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS521DWG4 | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS521DWR | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |





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| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/ Ball Finish | MSL Peak Temp ⁽³⁾ | Samples (Requires Login) |
|------------------|-----------------------|--------------|--------------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| SN74ALS521DWRE4 | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS521DWRG4 | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS521N | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | |
| SN74ALS521NE4 | ACTIVE | PDIP | N | 20 | 20 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | |
| SN74ALS521NSR | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS521NSRE4 | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74ALS521NSRG4 | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SNJ54ALS520FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | |
| SNJ54ALS520J | ACTIVE | CDIP | J | 20 | 1 | TBD | A42 | N / A for Pkg Type | |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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5-Sep-2011

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OTHER QUALIFIED VERSIONS OF SN54ALS520, SN74ALS520:

Catalog: SN74ALS520

Military: SN54ALS520

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

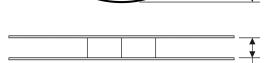
PACKAGE MATERIALS INFORMATION

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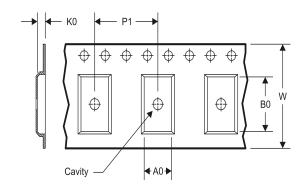
TAPE AND REEL INFORMATION

REEL DIMENSIONS





TAPE DIMENSIONS



| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

TAPE AND REEL INFORMATION

*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74ALS520NSR | SO | NS | 20 | 2000 | 330.0 | 24.4 | 8.2 | 13.0 | 2.5 | 12.0 | 24.0 | Q1 |
| SN74ALS521DWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.0 | 2.7 | 12.0 | 24.0 | Q1 |
| SN74ALS521NSR | SO | NS | 20 | 2000 | 330.0 | 24.4 | 8.2 | 13.0 | 2.5 | 12.0 | 24.0 | Q1 |

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*All dimensions are nominal

| 7 til dillionorono dio monimidi | | | | | | | |
|---------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| SN74ALS520NSR | SO | NS | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74ALS521DWR | SOIC | DW | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74ALS521NSR | SO | NS | 20 | 2000 | 367.0 | 367.0 | 45.0 |

14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



DW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Refer to IPC7351 for alternate board design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC—7525
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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